

Discription

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a ultra-small and flat lead SOD-323 plastic package designed to protect one signal line from the damage caused by ESD and other transients.



SOD-323

Features

- ★ Bidirectional ESD protection of one line
- ★ Reverse stand-off voltage: 3.3V Max
- ★ Low leakage current: nA Level
- ★ Response time is typically < 1 ns
- ★ Low clamping voltage:VC < 16V @IPP=20A
- ★ ESD Protection: 30kV(air)/30kV(contact) (IEC61000-4-2)
- ★ RoHS compliant



Circuit Diagram

Applications

- ★ Cell Phone Handsets and Accessories
- ★ Microprocessor based equipment
- ★ Personal Digital Assistants (PDA's)
- ★ Notebooks, Desktops, and Servers

Ordering Information

Product ID	Pack	Qty(PCS)
PESD3V3L1BAZ	SOD-323	3000



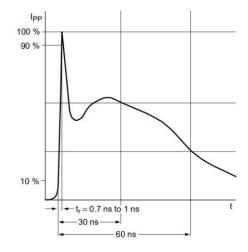
Absolute Ratings(Tamb = 25°C)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp = 8/20μs)	РРРМ	60	W
ESD voltage IEC 61000-4-2 (air discharge)	Vesd	30	kV
ESD voltage IEC 61000-4-2 (contact discharge)	VESD	30	kV
Maximum lead temperature for soldering during 10s	T∟	260	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Operating Temperature Range	Тор	-40 to +125	°C

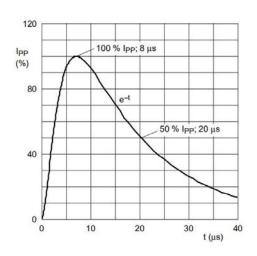
Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit	Condition	
Reverse Working Voltage	VRWM			3.3	V		
Breakdown Voltage	V _{BR}	4.0			V	I⊤=1mA	
Leakage Current ILeak	lr			40	uA	V _{RWM} =3.3V	
Clamping Voltage	Vc		-	7.5	V	Ipp=1A,T p=8/20µs	
	Vc			16	V	Ipp=20A,Тp=8/20µs	
Junction Capacitance	Сл		65	100	pF	V _R =0V, f=1MHz	

Typical Characteristics

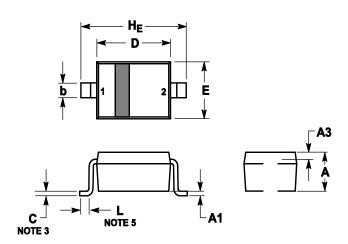


IEC61000-4-2 Waveform



IEC 61000-4-5 Waveform(8/20µs pulse)

Outline And Dimensions

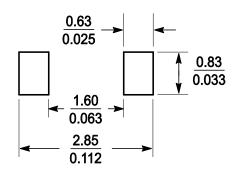


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.8	0.9	1	0.031	0.035	0.04
A1	0	0.05	0.1	0	0.002	0.004
A3	0.15REF			0.006REF		
b	0.25	0.32	0.4	0.01	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.6	1.7	1.8	0.062	0.066	0.07
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H _E	2.3	2.5	2.7	0.09	0.098	0.105

Soledering Footprint



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